

STS30N3LLH6

N-channel 30 V, 0.0016 Ω, 30 A, SO-8 STripFET™ VI DeepGATE™ Power MOSFET

Preliminary Data

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STS30N3LLH6	30 V	0.002 Ω	30 A

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses
- Very low switching gate charge

Application

Switching applications

Description

This product utilizes the 6th generation of design rules of ST's proprietary STripFET™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R_{DS(on)} in a standard package, that makes it suitable for the most demanding DC-DC converter applications, where high power density has to be achieved.

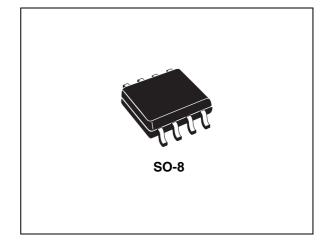


Figure 1. Internal schematic diagram

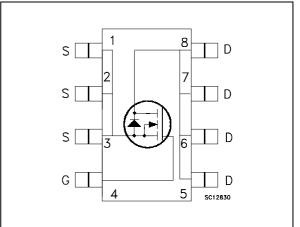


Table 1. **Device summary**

Order code	Marking	Packag	Packaging
STS30N3LLH6	30G3L	SO-8	Tape and reel

January 2009

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage ($V_{GS} = 0$)	30	V
$V_{GS}^{(1)}$	Gate-source voltage	± 20	V
Ι _D	Drain current (continuous) at T _C = 25 °C	30	А
I _D	Drain current (continuous) at T _C =100 °C	18.75	А
I _{DM} ⁽²⁾	Drain current (pulsed)	120	А
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	2.7	W
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

1. Continuous mode

2. Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-amb} ⁽¹⁾	Thermal resistance junction-ambient	47	°C/W

1. When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec

Table 4. Avalanche data

Symbol	Parameter	Value	Unit
I _{AV}	Not-repetitive avalanche current	TBD	А
E _{AS}	Single pulse avalanche energy (starting Tj=25 °C, I _D =I _{AV})	TBD	mJ

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5.	On/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	30			۷
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating, V _{DS} = Max rating @125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	$V_{GS} = \pm 20 V$			±100	nA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1			V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 15 A V _{GS} = 4.5 V, I _D = 15 A		0.0016 0.003	0.002 0.0035	Ω Ω

Table 5. On/off states

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0		3700 728 306		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =15 V, I _D = 30 A V _{GS} =4.5 V <i>Figure 8</i>		29 TBD TBD	TBD	nC nC nC
R _G	Gate Input Resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20 mV open drain		TBD		Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I _D = 15 A, R _G =4.7 Ω , V _{GS} =4.5 V <i>Figure 2</i>		TBD TBD TBD TBD		ns ns ns ns

Table 7.Switching times

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				30	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				120	А
V _{SD} ⁽²⁾	Forward on Voltage	I _{SD} =15 A, V _{GS} =0			1.1	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} =15 A, di/dt = 100 A/μs, V _{DD} =20 V, Tj=150 °C <i>Figure 4</i>		TBD TBD TBD		ns nC A

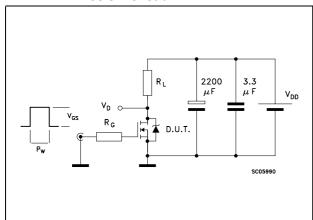
1. Pulse width limited by safe operating area

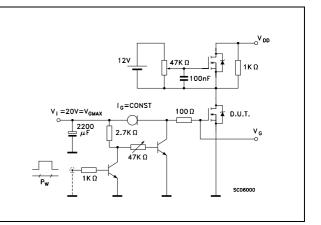
2. Pulsed: pulse duration=300 $\mu s,$ duty cycle 1.5%



3 **Test circuit**

Figure 2. Switching times test circuit for resistive load





Gate charge test circuit

Figure 3.

Figure 4. Test circuit for inductive load switching and diode recovery times

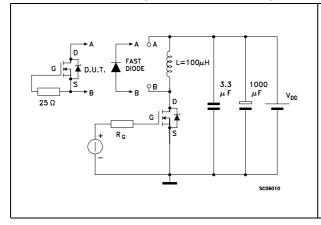


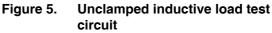
Figure 6. Unclamped inductive waveform

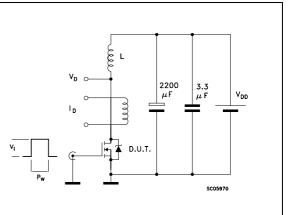
V_D -

I _{DM}

 $|_{D}$

VDD





 V_{DD}

SC05980

 $V_{(BR)DSS}$

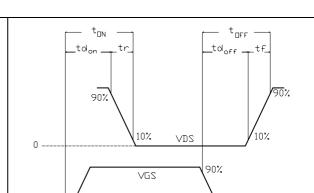


Figure 7. Switching time waveform

, 10%

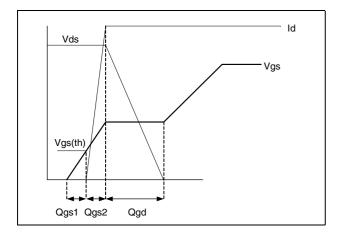
0.-

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SC50050

Figure 8. Gate charge waveform





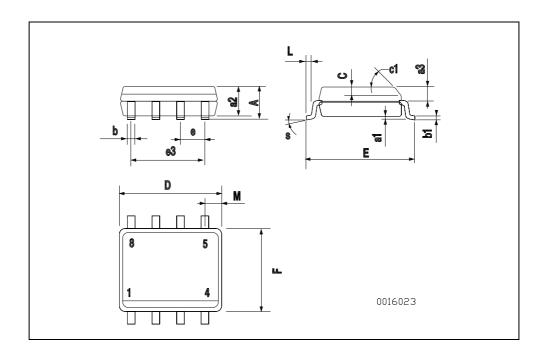
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.



DIM		mm.			inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1		•	45 ((typ.)	•	
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023





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5 Revision history

Table 9.Document revision history

Date	Revision	Changes
27-Jan-2009	1	First release

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